### 1. General description

The 74LVC1G14 provides the inverting buffer function with Schmitt-trigger input. It is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

The input can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment. Schmitt-trigger action at the input makes the circuit tolerant for slower input rise and fall time.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8-B/JESD36 (2.7 V to 3.6 V).
- $\pm 24$  mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Unlimited rise and fall times
- Input accepts voltages up to 5 V
- Multiple package options
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V.
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

### 3. Applications

- Wave and pulse shaper
- Astable multivibrator
- Monostable multivibrator



Single Schmitt-trigger inverter

## 4. Ordering information

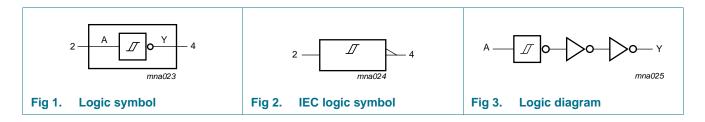
Table 1. Ordering	g information			
Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G14GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74LVC1G14GV	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74LVC1G14GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886
74LVC1G14GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm	SOT891
74LVC1G14GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115
74LVC1G14GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202

### 5. Marking

Table 2. Marking	
Type number	Marking code <sup>[1]</sup>
74LVC1G14GW	VF
74LVC1G14GV	V14
74LVC1G14GM	VF
74LVC1G14GF	VF
74LVC1G14GN	VF
74LVC1G14GS	VF

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

### 6. Functional diagram

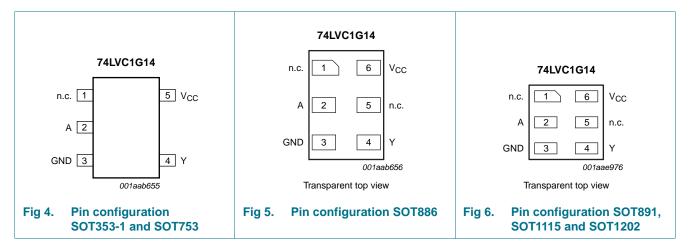


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## 7. Pinning information

#### 7.1 Pinning



#### 7.2 Pin description

Symbol	Pin		Description
	SOT353-1, SOT753	SOT353-1, SOT753 SOT886, SOT891, SOT1115, SOT1202	
n.c.	1	1	not connected
A	2	2	data input
GND	3	3	ground (0 V)
Y	4	4	data output
n.c.	-	5	not connected
V <sub>CC</sub>	5	6	supply voltage

## 8. Functional description

#### Table 4.Function table<sup>[1]</sup>

Input	Output
Α	Y
L	Н
Н	L

[1] H = HIGH voltage level; L = LOW voltage level

### 9. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				-	
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Vo	output voltage	Active mode	<u>[1][2]</u> –0.5	V <sub>CC</sub> + 0.5	V
		Power-down mode	<u>[1][2]</u> –0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	+100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u> _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When  $V_{CC} = 0 V$  (Power-down mode), the output voltage can be 5.5 V in normal operation.

### **10. Recommended operating conditions**

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V <sub>CC</sub>	V
		Power-down mode; $V_{CC} = 0 V$	0	-	5.5	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C

### **11. Static characteristics**

#### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °	°C to +85	°C	-40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V <sub>OH</sub>	HIGH-level	$V_I = V_{T+}$ or $V_{T-}$						
	output voltage	I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 5.5 V	$V_{CC}-0.1$	-	-	V <sub>CC</sub> - 0.1	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	1.54	-	0.95	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	2.15	-	1.7	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	2.50	-	1.9	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	2.62	-	2.0	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	4.11	-	3.4	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{T+} \text{ or } V_{T-}$						
output voltag	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 5.5 V	-	-	0.10	-	0.10	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.07	0.45	-	0.70	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.12	0.30	-	0.45	V
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V	-	0.17	0.40	-	0.60	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.33	0.55	-	0.80	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.39	0.55	-	0.80	V
I	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	±0.1	±5	-	±100	μA
I <sub>OFF</sub>	power-off leakage current	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	±0.1	±10	-	±200	μΑ
I <sub>CC</sub>	supply current	$V_{I} = 5.5 \text{ V or GND}; I_{O} = 0 \text{ A};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	-	0.1	10	-	200	μA
∆l <sub>CC</sub>	additional supply current		-	5	500	-	5000	μA
CI	input capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = GND to $V_{CC}$	-	5.0	-	-	-	pF

[1] All typical values are measured at maximum V<sub>CC</sub> and T<sub>amb</sub> = 25 °C.

#### Table 8. Transfer characteristics

Voltages are referenced to GND (ground = 0 V); for load circuit see Figure 8.

Symbol	Parameter Conditions		-40	–40 °C to +85 °C			–40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Max	Min	Max		
$V_{T+}$	positive-going	see Figure 9 and Figure 10							
	threshold voltage	V <sub>CC</sub> = 1.8 V	0.82	1.0	1.14	0.79	1.14	V	
		$V_{CC} = 2.3 V$	1.03	1.2	1.40	1.00	1.40	V	
		$V_{CC} = 3.0 V$	1.29	1.5	1.71	1.26	1.71	V	
	$V_{CC} = 4.5 V$	1.84	2.1	2.36	1.81	2.36	V		
		$V_{CC} = 5.5 V$	2.19	2.5	2.79	2.16	2.79	V	

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•								
Symbol Parameter		Conditions	-40	–40 °C to +85 °C			o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
$V_{T-}$	negative-going	see Figure 9 and Figure 10						
	threshold voltage	V <sub>CC</sub> = 1.8 V	0.46	0.6	0.75	0.46	0.78	V
		$V_{CC} = 2.3 V$	0.65	0.8	0.96	0.65	0.99	V
		$V_{CC} = 3.0 V$	0.88	1.0	1.24	0.88	1.27	V
		$V_{CC} = 4.5 V$	1.32	1.5	1.84	1.32	1.87	V
		$V_{CC} = 5.5 V$	1.58	1.8	2.24	1.58	2.27	V
V <sub>H</sub>	hysteresis voltage	(V <sub>T+</sub> – V <sub>T</sub> _); see <u>Figure 9,</u> <u>Figure 10</u> and <u>Figure 11</u>						
		V <sub>CC</sub> = 1.8 V	0.26	0.4	0.51	0.19	0.51	V
		$V_{CC} = 2.3 V$	0.28	0.4	0.57	0.22	0.57	V
		$V_{CC} = 3.0 V$	0.31	0.5	0.64	0.25	0.64	V
		$V_{CC} = 4.5 V$	0.40	0.6	0.77	0.34	0.77	V
		V <sub>CC</sub> = 5.5 V	0.47	0.6	0.88	0.41	0.88	V

#### Table 8. Transfer characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for load circuit see <u>Figure 8</u>.

[1] All typical values are measured at  $T_{amb} = 25 \text{ °C}$ 

### **12. Dynamic characteristics**

#### Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for load circuit see Figure 8.

Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation delay	A to Y; see Figure 7	[2]						
		$V_{CC}$ = 1.65 V to 1.95 V		1.0	4.1	11.0	1.0	14.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		0.7	2.8	6.5	0.7	8.5	ns
		$V_{CC} = 2.7 V$		0.7	3.2	6.5	0.7	8.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		0.7	3.0	5.5	0.7	7.0	ns
		$V_{CC}$ = 4.5 V to 5.5 V		0.7	2.2	5.0	0.7	6.5	ns
C <sub>PD</sub>	power dissipation capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = GND to $V_{CC}$	<u>[3]</u>	-	15.4	-	-	-	pF

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_i + (\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_o) \text{ where:}$ 

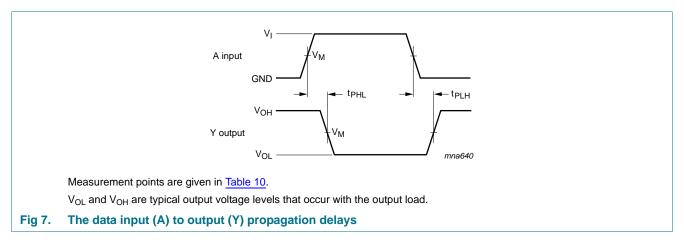
 $f_i = input frequency in MHz;$ 

 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

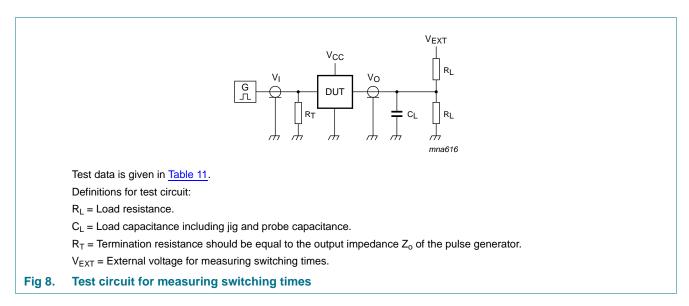
 $V_{CC}$  = supply voltage in V.

### 13. Waveforms



#### Table 10.Measurement points

Supply voltage	Input	Output
V <sub>cc</sub>	V <sub>M</sub>	V <sub>M</sub>
1.65 V to 1.95 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
2.3 V to 2.7 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>



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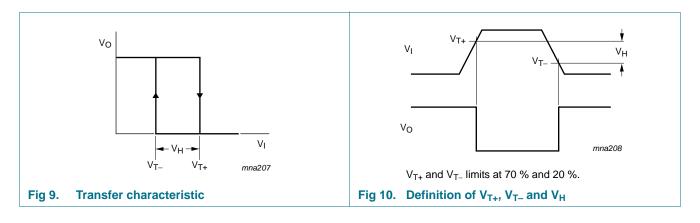
## 74LVC1G14

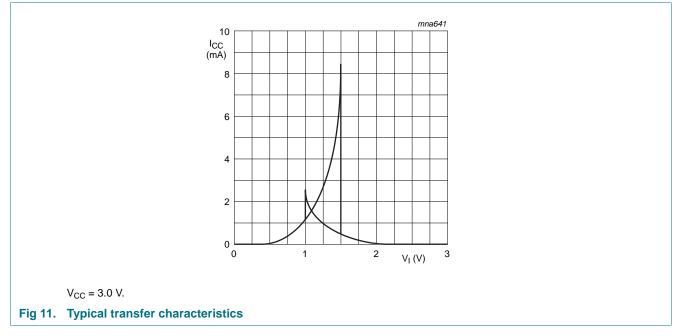
#### Single Schmitt-trigger inverter

#### Table 11. Test data

Supply voltage	Input		Load	Load	
V <sub>CC</sub>	VI	$t_r = t_f$	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2.0 ns	30 pF	1 kΩ	open
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2.0 ns	30 pF	500 Ω	open
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	open

## 14. Waveforms transfer characteristics





## **15. Application information**

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

 $P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC} \text{ where:}$ 

 $P_{add}$  = additional power dissipation ( $\mu$ W);

 $f_i = input frequency (MHz);$ 

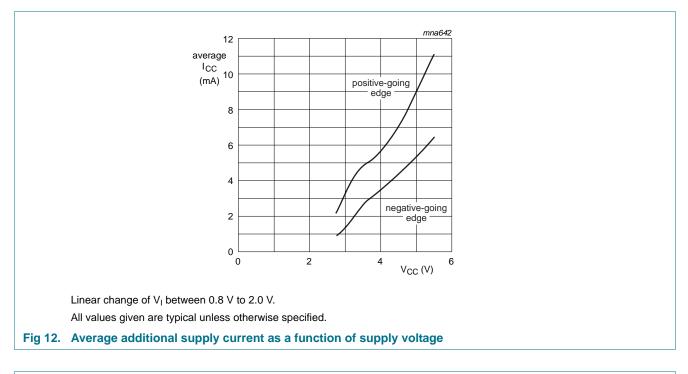
 $t_r$  = input rise time (ns); 10 % to 90 %;

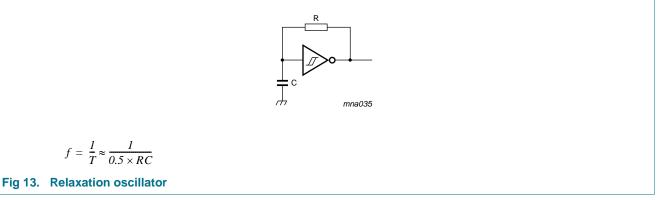
 $t_f$  = input fall time (ns); 90 % to 10 %;

 $\Delta I_{CC(AV)}$  = average additional supply current (µA).

Average  $\Delta I_{CC(AV)}$  differs with positive or negative input transitions, as shown in Figure 12.

An example of a relaxation circuit using the 74LVC1G14 is shown in Figure 13.



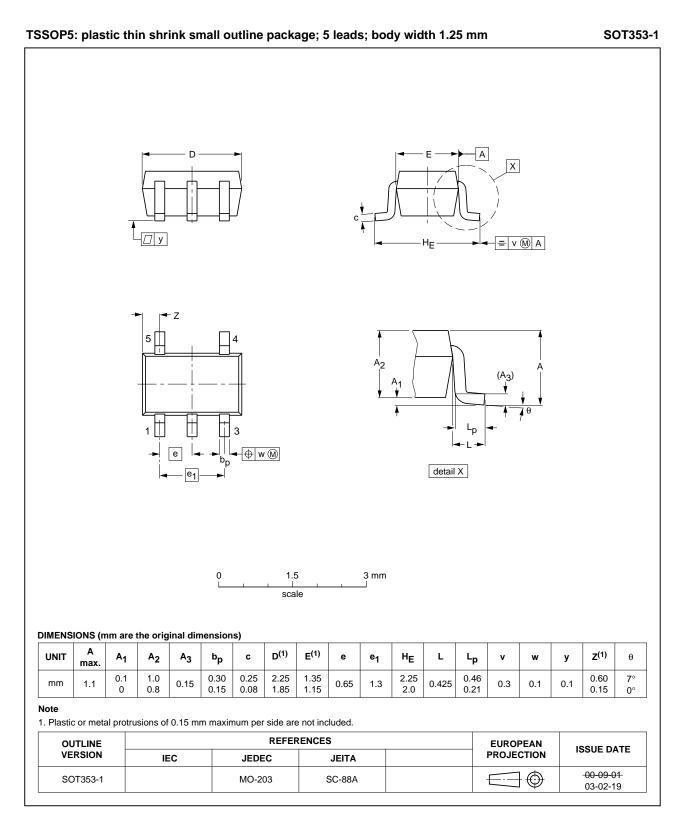


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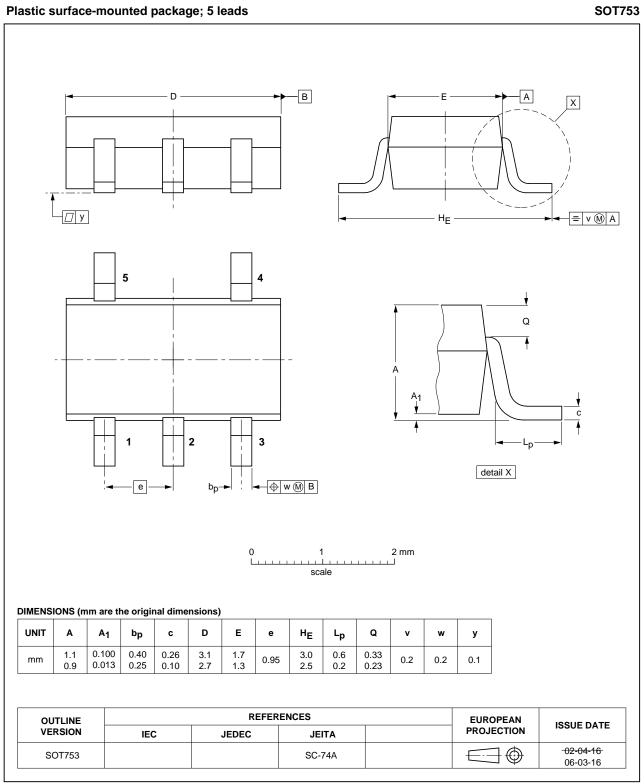
### 16. Package outline



#### Fig 14. Package outline SOT353-1 (TSSOP5)

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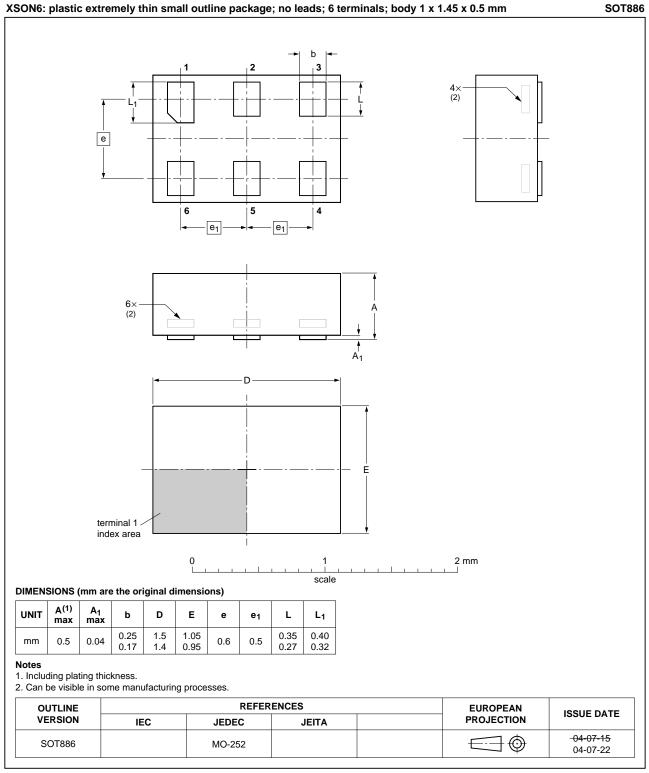


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Fig 15. Package outline SOT753 (SC-74A)

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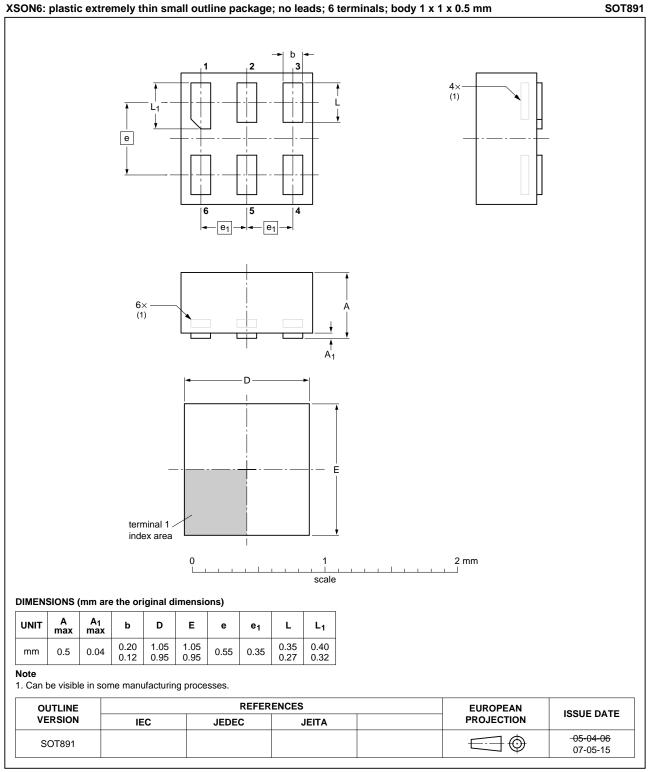
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#### XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

Fig 16. Package outline SOT886 (XSON6)

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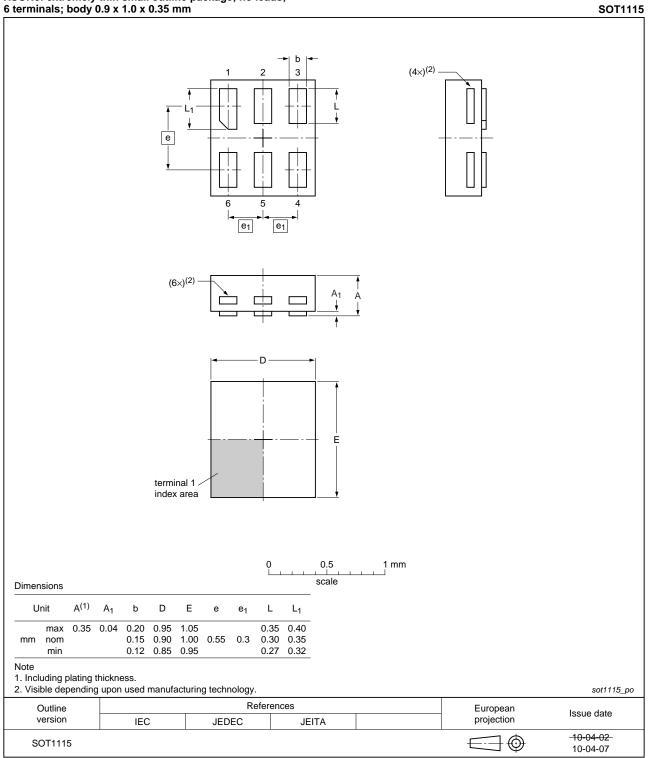
XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

#### Fig 17. Package outline SOT891 (XSON6)

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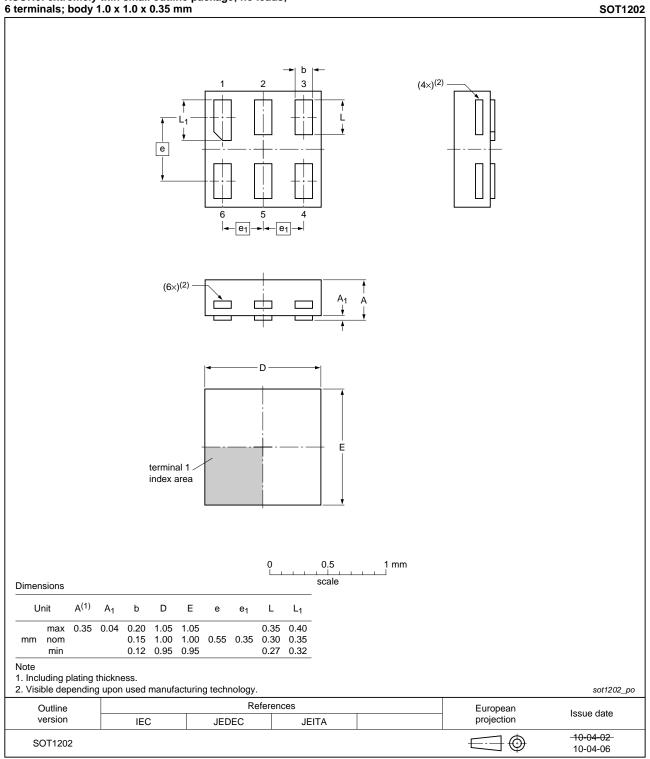
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#### XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 18. Package outline SOT1115 (XSON6)

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# XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 19. Package outline SOT1202 (XSON6)

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### **17. Abbreviations**

Table 12. Abbreviations			
Acronym	Description		
CMOS	Complementary Metal Oxide Semiconductor		
TTL	Transistor-Transistor Logic		
HBM	Human Body Model		
ESD	ElectroStatic Discharge		
MM	Machine Model		
DUT	Device Under Test		

### 18. Revision history

#### Table 13. **Revision history Document ID** Supersedes **Release date** Data sheet status **Change notice** 74LVC1G14 v.9 20110922 Product data sheet 74LVC1G14 v.8 \_ Modifications: • Conditions for HIGH-level output voltage and LOW-level output voltage changed (errata). 74LVC1G14 v.8 Product data sheet 74LVC1G14 v.7 20101110 Modifications: Added type number 74LVC1G14GN (SOT1115 / XSON6 package). Added type number 74LVC1G14GS (SOT1202 / XSON6 package). 74LVC1G14 v.7 20070718 Product data sheet \_ 74LVC1G14 v.6 74LVC1G14 v.6 Product data sheet 74LVC1G14 v.5 20060615 -74LVC1G14 v.5 20040910 Product specification -74LVC1G14 v.4 74LVC1G14 v.4 Product specification 74LVC1G14 v.3 20021119 \_ 74LVC1G14 v.3 74LVC1G14 v.2 20020521 Product specification -74LVC1G14 v.2 20010406 Product specification -74LVC1G14 v.1 74LVC1G14 v.1 20001212 Product specification -\_

### **19. Legal information**

#### **19.1 Data sheet status**

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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#### Single Schmitt-trigger inverter

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#### Single Schmitt-trigger inverter

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